TOSHIBA Transistor Silicon NPN / PNP Epitaxial Type (PCT Process)

TPCP8901

Portable Equipment Applications Switching Applications

· Small footprint due to small and thin package

• High DC current gain : PNP $h_{FE} = 200 \text{ to } 500 \text{ (I}_{C} = -0.1 \text{ A)}$

:NPN $h_{FE} = 400 \text{ to } 1000 \text{ (IC} = 0.1 \text{ A)}$

• Low collector-emitter saturation : PNP $V_{CE (sat)} = -0.20 \text{ V (max)}$

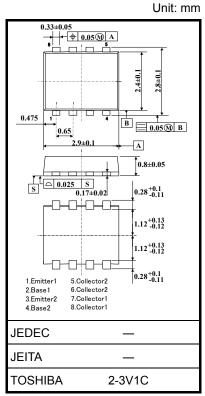
: NPN $V_{CE (sat)} = 0.17 \text{ V (max)}$

• High-speed switching: PNP $t_f = 70 \text{ ns (typ.)}$

: NPN $t_f = 85 \text{ ns (typ.)}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating		Unit	
Character	Зупівої	PNP	NPN	Offic		
Collector-base voltage		V_{CBO}	-50	100	٧	
Collector-emitter voltage		V_{CEO}	-50	50	>	
Emitter-base voltage		V_{EBO}	-7	7	>	
Collector current	DC (Note 1)	IC	-0.8	1.0	Α	
	Pulse (Note 1)	I _{CP}	-5.0	5.0	4	
Base current		ΙΒ	-100	100	mA	
Collector power dissipation (t = 10s)	Single-device operation		0.80		W	
	Single-device value at dual operation	P _C (Note 2)				
Collector power dissipation (DC)	Single-device operation		0.83		W	
	Single-device value at dual operation	P _C (Note 2)		18		
Junction temperature		Tj	150		°C	
Storage temperature range		T _{stg}	-55 to 150		°C	



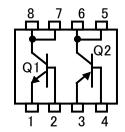
Weight: 0.017 g (typ.)

- Note 1: Please use devices on condition that the junction temperature is below 150°C. Icp=±5A (@ t≦100 μ s)
- Note 2: Mounted on FR4 board (glass epoxy, 1.6 mm thick, Cu area: 645 mm²)
- Note 3: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production 2004-01

Figure 1. Circuit configuration (top view)



Note 4: • on lower left on the marking indicates Pin 1.

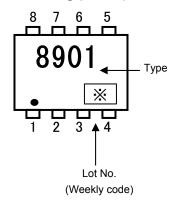
Weekly code: (Three digits)
 Week of manufacture

 (01 for first week of year, continues up to 52 or 53)

 Year of manufacture

 (One low-order digits of calendar year)

Figure 2. Marking (Note 4)



Electrical Characteristics (Ta = 25°C)

PNP

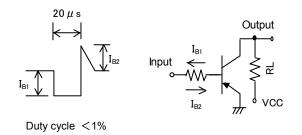
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current		I _{CBO}	$V_{CB} = -50 \text{ V}, I_{E} = 0$	_	_	-100	nA
Emitter cut-off current		I _{EBO}	$V_{EB} = -7 \text{ V, } I_{C} = 0$	_	_	-100	nA
Collector-emitter br	eakdown voltage	V (BR) CEO	$I_C = -10 \text{ mA}, I_B = 0$	-50	_	_	V
DC current gain		h _{FE} (1)	$V_{CE} = -2 \text{ V}, I_{C} = -0.1 \text{ A}$	200	_	500	
		h _{FE} (2)	$V_{CE} = -2 \text{ V}, I_{C} = -0.3 \text{ A}$	125	_	_	
Collector-emitter saturation voltage		V _{CE (sat)}	$I_C = -0.3 \text{ A}, I_B = -0.01 \text{ A}$	_	_	-0.20	V
Base-emitter saturation voltage		V _{BE (sat)}	$I_C = -0.3 \text{ A}, I_B = -0.01 \text{ A}$	_	_	-1.10	V
Collector output capacitance		C _{ob}	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{MHz}$	_	8	_	pF
Switching time	Rise time	t _r	See Figure 3 circuit diagram $\begin{array}{l} \text{V}_{CC} \simeq -30 \text{ V, R}_L = 100 \ \Omega \\ -\text{I}_{B1} = \text{I}_{B2} = -10 \text{ mA} \end{array}$	_	60	_	ns
	Storage time	t _{stg}		_	280	_	
	Fall time	t _f		_	70	_	

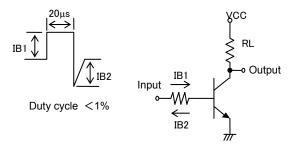
NPN

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current		I _{CBO}	V _{CB} = 100 V, I _E = 0	_	_	100	nA
Emitter cut-off current		I _{EBO}	V _{EB} = 7 V, I _C = 0	_	_	100	nA
Collector-emitter breakdown voltage		V (BR) CEO	$I_C = 10 \text{ mA}, I_B = 0$	50	_	_	V
DC current gain		h _{FE} (1)	V _{CE} = 2 V, I _C = 0.1 A	400	_	1000	
		h _{FE} (2)	V _{CE} = 2 V, I _C = 0.3 A	200	_	_	
Collector-emitter saturation voltage		V _{CE} (sat)	$I_C = 300 \text{ mA}, I_B = 6 \text{ mA}$	_	_	0.17	V
Base-emitter saturation voltage		V _{BE (sat)}	$I_C = 300 \text{ mA}, I_B = 6 \text{ mA}$	_	_	1.10	V
Collector output capacitance		C _{ob}	V _{CB} = 10 V, I _E = 0, f = 1MHz	_	5	_	pF
Switching time	Rise time	t _r	See Figure 4 circuit diagram $V_{CC} \simeq 30 \text{ V}, \text{ R}_L = 100 \ \Omega$ $I_{B1} = -I_{B2} = 10 \text{ mA}$	_	35	_	
	Storage time	t _{stg}		_	680	_	ns
	Fall time	t _f		_	85	—	

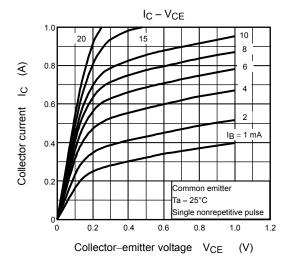
Figure 3. Switching Time Test Circuit & Timing Chart

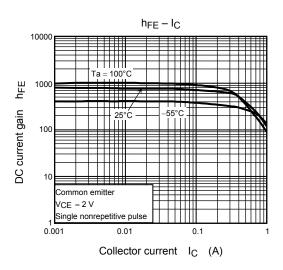
Figure 4. Switching Time Test Circuit & Timing Chart

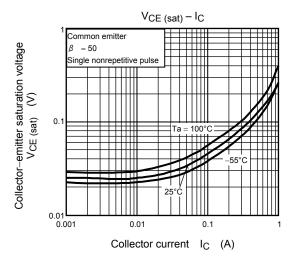


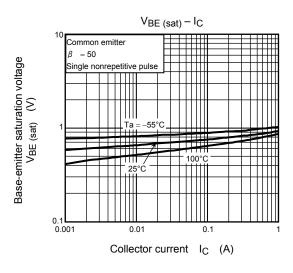


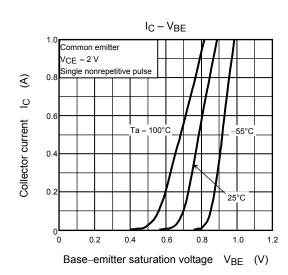
NPN

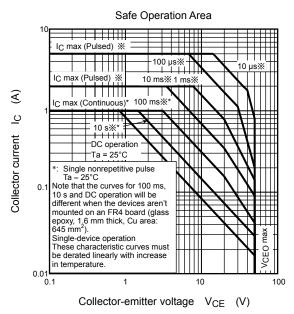




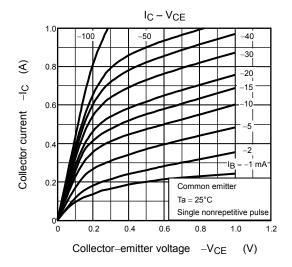


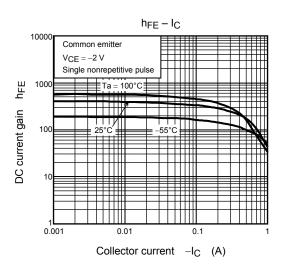


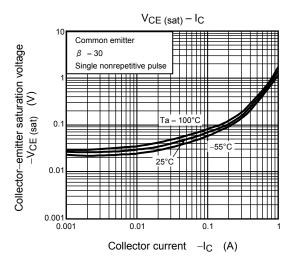


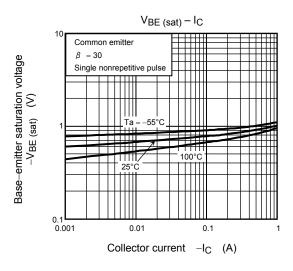


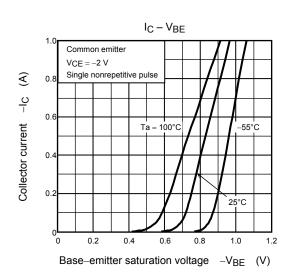
PNP

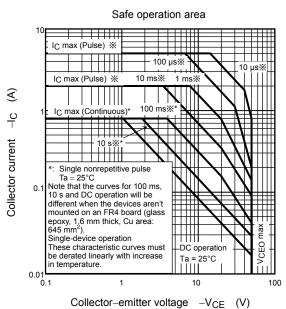






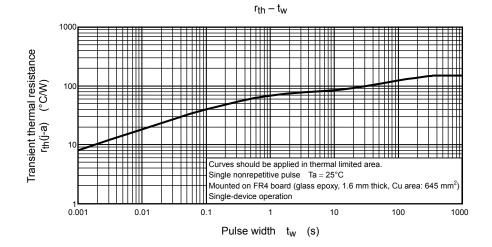


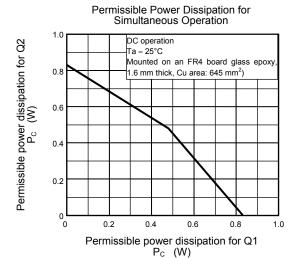




5

Common





Collector power dissipation at the single-device operation is 0.83W.

Collector power dissipation at the single-device value at dual operation is 0.48W.

Collector power dissipation at the dual operation is set to 0.96W.

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